

IGBT Module

SK50GD126T

Preliminary Data

Features

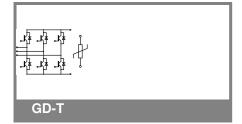
- One screw mounting module
 Fully compatible with SEMITOP®1,2,3
- Improved thermal performances by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications*

- Inverter up to 28 kVA
- Typ. motor power 15 kW

| Absolute Maximum Ratings $T_s = 25 ^{\circ}\text{C}$, unless otherwise specified | | | | | | | | | |
|---|---|-------------------------|--|------------------|-------|--|--|--|--|
| Symbol | Conditions | | | Values | Units | | | | |
| IGBT | | | | | | | | | |
| V_{CES} | T _j = 25 °C | | | 1200 | V | | | | |
| I _C | T _j = 150 °C | T _s = 25 °C | | 68 | Α | | | | |
| | | $T_s = 70 ^{\circ}C$ | | 52 | Α | | | | |
| I _{CRM} | I _{CRM} = 2 x I _{Cnom} | | | 100 | Α | | | | |
| $V_{\rm GES}$ | | | | ± 20 | V | | | | |
| t _{psc} | V_{CC} = 600 V; $V_{GE} \le 20$ V; $V_{CES} < 1200$ V | T _j = 125 °C | | 10 | μs | | | | |
| Inverse Diode | | | | | | | | | |
| I_{F} | T _j = 150 °C | $T_s = 25 ^{\circ}C$ | | 62 | Α | | | | |
| | | $T_s = 70 ^{\circ}C$ | | 46 | Α | | | | |
| I _{FRM} | I _{FRM} = 2 x I _{Fnom} | | | 100 | Α | | | | |
| Module | | | | | | | | | |
| $I_{t(RMS)}$ | | | | | Α | | | | |
| T_{vj} | | | | -40 + 150 | °C | | | | |
| T _{stg} | | | | -40 +12 5 | °C | | | | |
| V _{isol} | AC, 1 min. | | | 2500 | V | | | | |

| Characteristics T _s = 25 °C, unless otherwise specified | | | | | | | | |
|---|--|---|------|-------|--------|-----------|--|--|
| Symbol | Conditions | | min. | typ. | max. | Units | | |
| IGBT | | | | | | | | |
| $V_{GE(th)}$ | $V_{GE} = V_{CE}$, $I_C = 2 \text{ mA}$ | | 5 | 5,8 | 6,5 | V | | |
| I _{CES} | $V_{GE} = 0 V, V_{CE} = V_{CES}$ | T _j = 25 °C | | | 0,0067 | mA | | |
| | | T _j = 125 °C | | | | mA | | |
| I_{GES} | V _{CE} = 0 V, V _{GE} = 20 V | T _j = 25 °C | | | 600 | nA | | |
| | | T _j = 125 °C | | | | nA | | |
| V _{CE0} | | T _j = 25 °C | | 1 | 1,2 | V | | |
| | | T _j = 125 °C | | 0,9 | 1,1 | V | | |
| r _{CE} | V _{GE} = 15 V | T _j = 25°C | | 14 | 19 | mΩ | | |
| | | T _j = 125°C | | 22 | 27 | $m\Omega$ | | |
| V _{CE(sat)} | I _{Cnom} = 50 A, V _{GE} = 15 V | T _j = 25°C _{chiplev.} | | 1,7 | 2,1 | V | | |
| | | $T_j = 125^{\circ}C_{chiplev.}$ | | 2 | 2,45 | V | | |
| C _{ies} | | | | 3,6 | | nF | | |
| C _{oes} | $V_{CE} = 25, V_{GE} = 0 V$ | f = 1 MHz | | 0,188 | | nF | | |
| C _{res} | | | | 0,163 | | nF | | |
| $t_{d(on)}$ | | | | 115 | | ns | | |
| t _r | $R_{Gon} = 8 \Omega$ | V _{CC} = 600V | | 28 | | ns | | |
| E _{on} | | I _C = 50A | | 4,6 | | mJ | | |
| $t_{d(off)}$ | $R_{Goff} = 8 \Omega$ | T _j = 125 °C | | 509 | | ns | | |
| t _f | | V _{GE} = -7/ +15 V | | 100 | | ns | | |
| E_{off} | | | | 6,3 | | mJ | | |
| $R_{th(j-s)}$ | per IGBT | | | 0,6 | | K/W | | |





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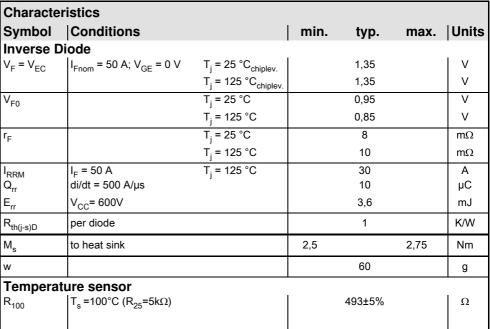
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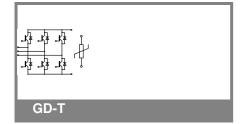
Typical Applications*

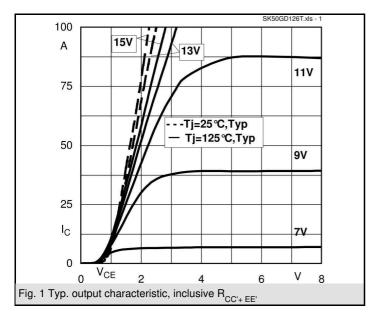
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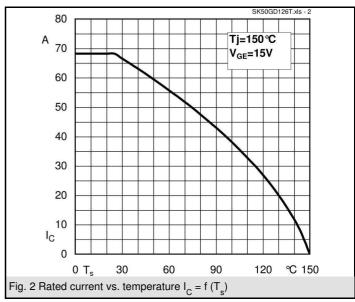


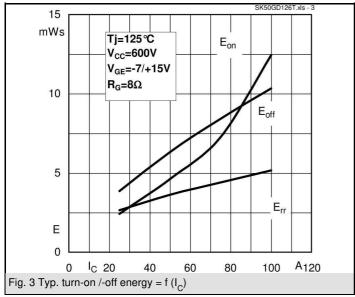
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

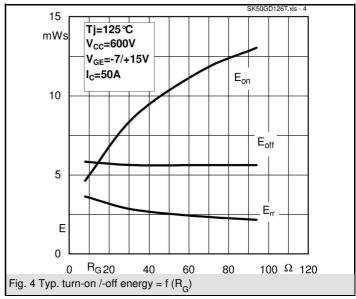
* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

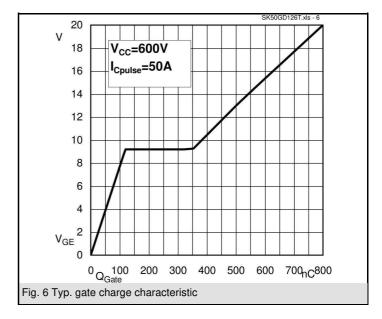


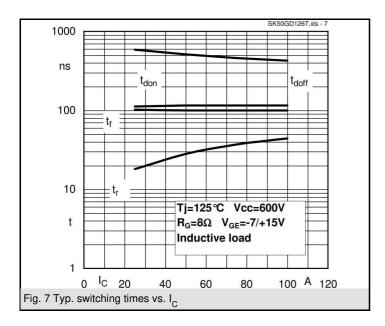


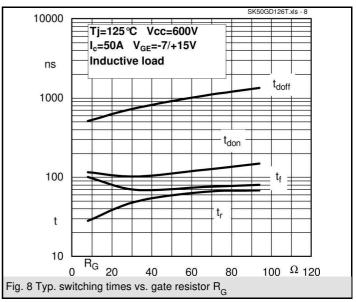


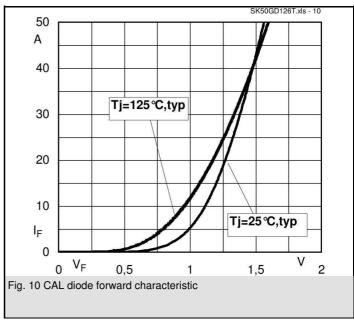


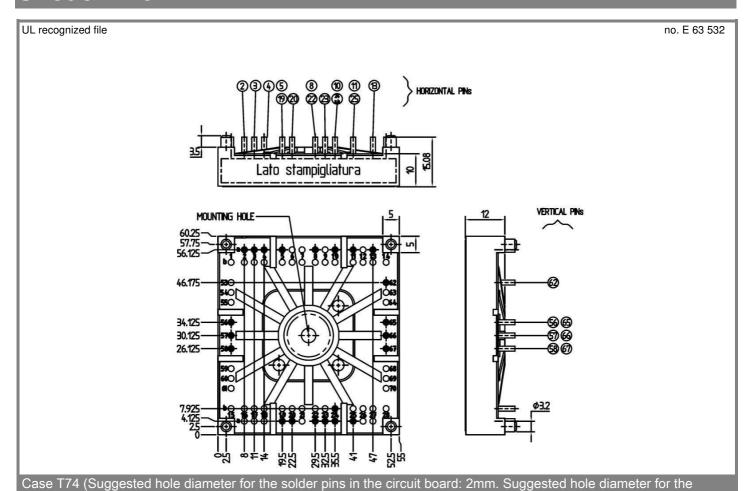


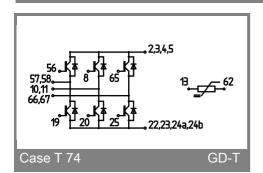












mounting pins in the circuit board: 3,6mm)

5 27-08-2008 DIL © by <u>SEMIKRON</u>